

# Device Modeling Report

COMPONENTS: THYRISTOR  
PART NUMBER: MCR225-2FP  
MANUFACTURER: MOTOROLA SEMICONDUCTOR



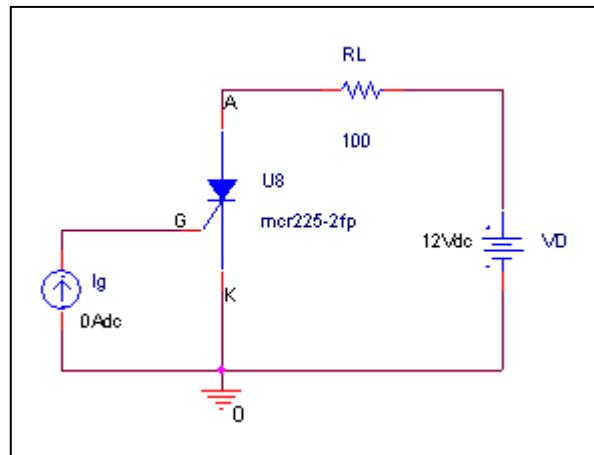
**Bee Technologies Inc.**

## DIODE MODEL

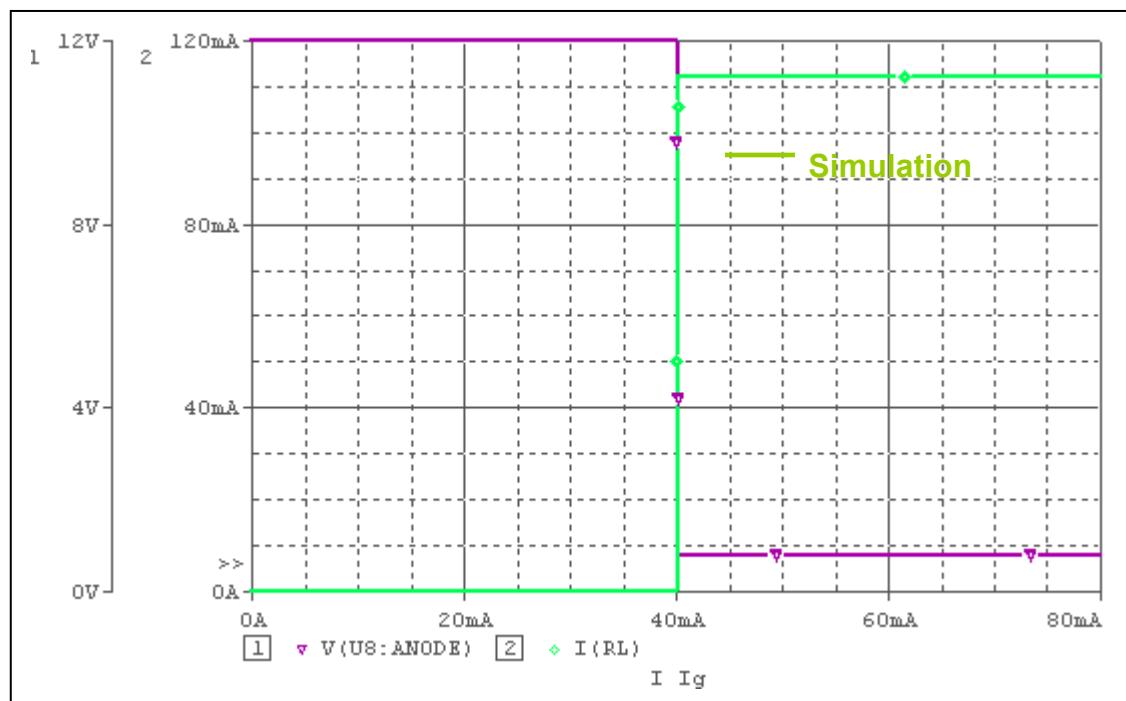
Pspice model Parameter	Model description
IS	Saturation Current
N	Emission Coefficient
RS	Series Resistance
IKF	High-injection Knee Current
CJO	Zero-bias Junction Capacitance
M	Junction Grading Coefficient
VJ	Junction Potential
ISR	Recombination Current Saturation Value
BV	Reverse Breakdown Voltage(a positive value)
IBV	Reverse Breakdown Current(a positive value)
TT	Transit Time

## IG-VT Characteristic

Evaluation Circuit



Simulation result

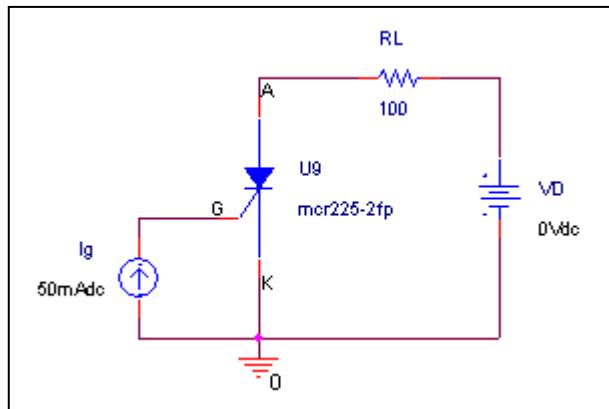


Comparison Table

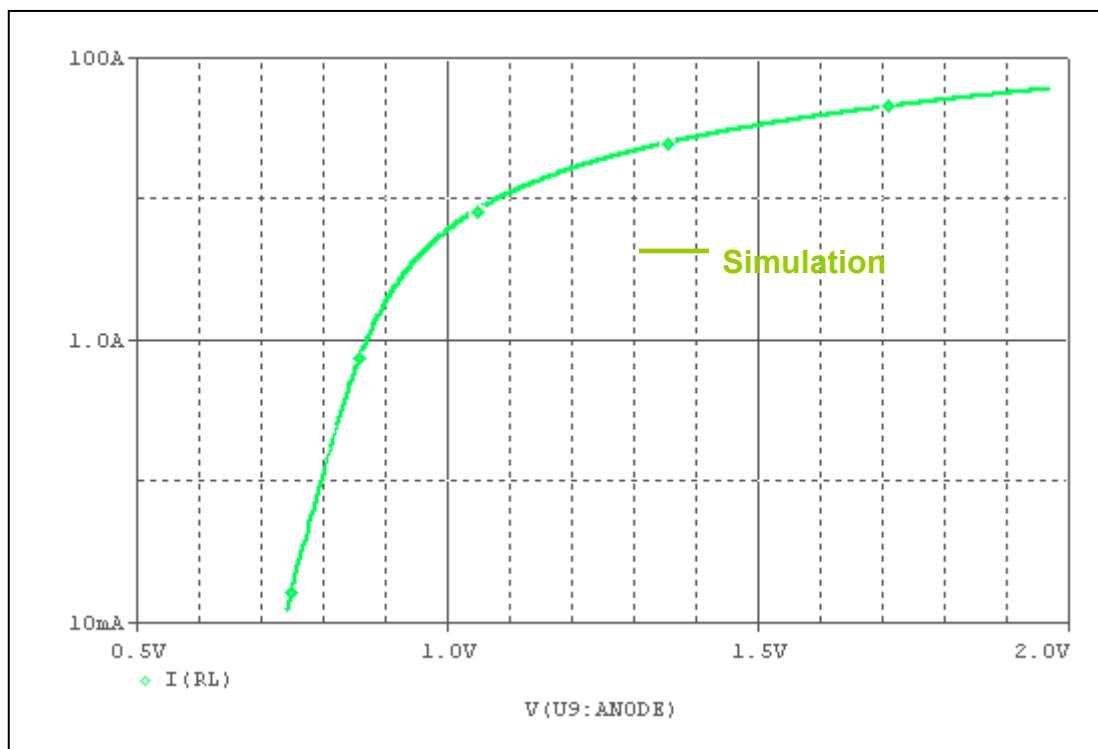
	Measurement	Simulation	% Error
$I_{G_T}$ (mA)	40(max)	40	0
$V_{G_T}$ (V)	0.8	0.799302	-0.08725

## ITM-VTM Characteristic

Evaluation Circuit



Simulation result

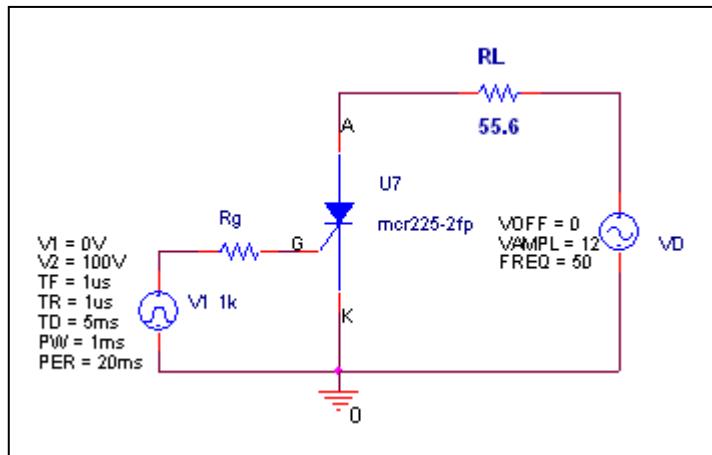


Comparison Table

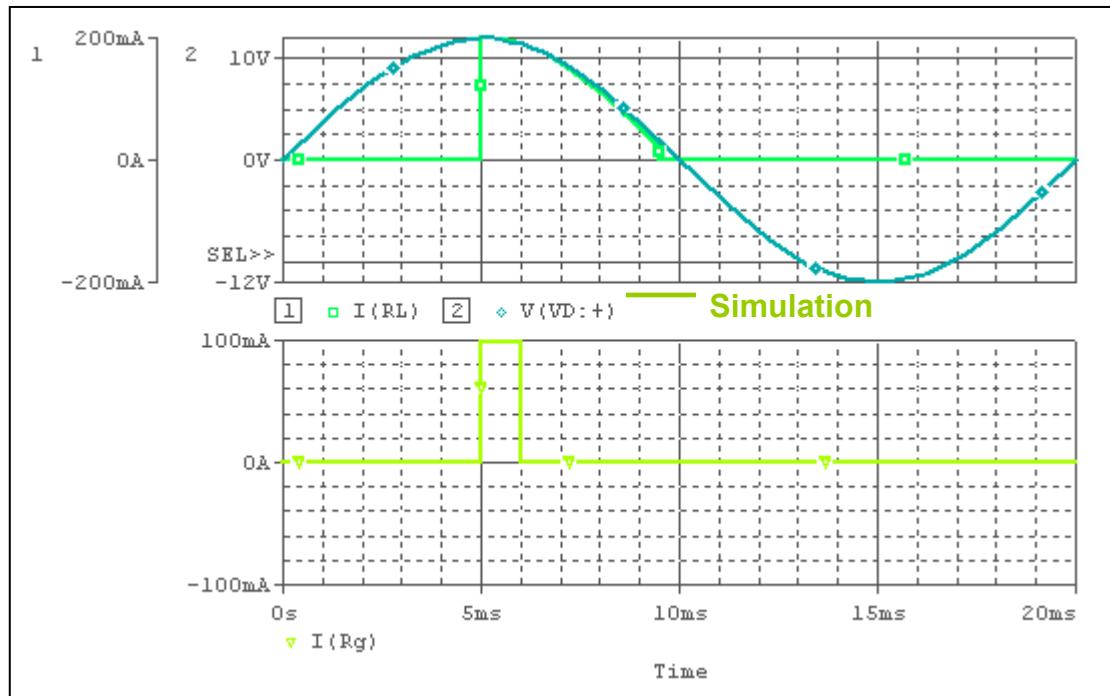
At ITM=50A	Measurement	Simulation	% Error
VTM(V)	1.8(max)	1.7964	-0.20000

## Holding Characteristic (IH)

### Evaluation Circuit



### Simulation result

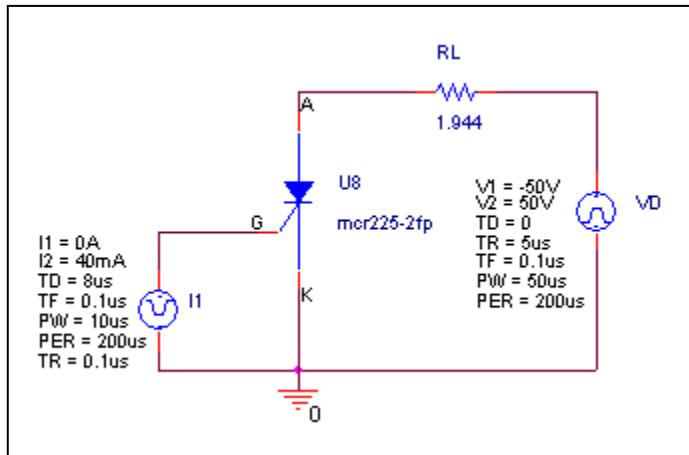


### Comparison Table

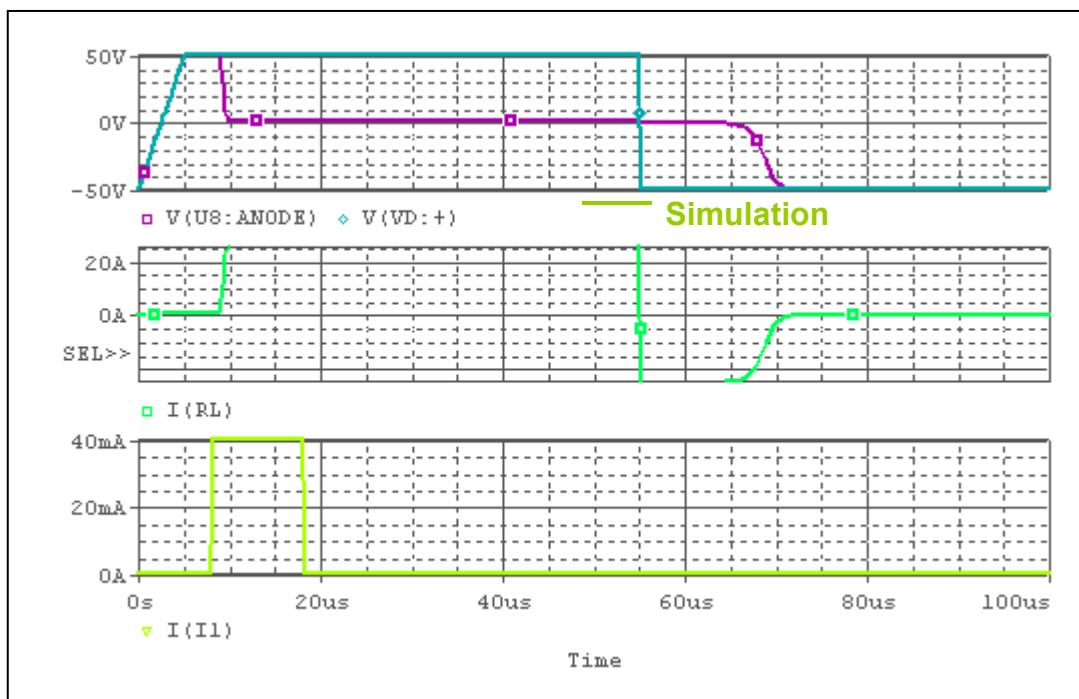
VD=12V	Measurement	Simulation	% Error
IH(mA)	20	19.905	-0.47500

## Switching Time Characteristic

Evaluation Circuit



Simulation result



Comparison Table

	Measurement	Simulation	%Error
Ton(us)	1.5	1.5536	3.57333
Toff(us)	15	15.127	0.84667